



NCE N-Channel Super Trench Power MOSFET



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP6050AQU	NCEP6050AQU	DFN3.3X3.3-8L	-	-	-

Absolute Maximum Ratings (Tc=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	60	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	Ι _D	50	А
Drain Current-Continuous(T_c=100 $^\circ \! {\mathbb C}$)	l _D (100℃)	39	A
Pulsed Drain Current	I _{DM}	200	A
Maximum Power Dissipation	PD	60	W
Derating factor		0.48	W/° C
Single pulse avalanche energy (Note 1)	E _{AS}	350	mJ
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 To 150	°C

Thermal Characteristic

Thermal Resistance,Junction-to-Case	Rejc	2.1	°C/W
Thermai resistance, sunction-to-base	I VAJC	2.1	C/VV



Electrical Characteristics (Tc=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	60		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =60V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V	-	-	±100	nA
On Characteristics						
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1.2	1.8	2.4	V
Drain Source On State Registeres		V _{GS} =10V, I _D =25A	-	6.5	7.5	mΩ
Drain-Source On-State Resistance	RDS(ON)	V _{GS} =4.5V, I _D =25A	-	7.7	8.8	
Forward Transconductance	g fs	V _{DS} =5V,I _D =25A		60	-	S
Dynamic Characteristics			·			
Input Capacitance	Clss		-	2000	-	PF
Output Capacitance	Coss	$V_{DS}=30V, V_{GS}=0V,$	-	315	-	PF
Reverse Transfer Capacitance	Crss	F=1.0MHZ	-	9.9	-	PF
Switching Characteristics (Note 2)	· · ·		•	•		
Turn-on Delay Time	t _{d(on)}		-	8	-	nS
Turn-on Rise Time	tr	V _{DD} =30V,I _D =25A	-	2	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{G} =1.6 Ω	-	29	-	nS
Turn-Off Fall Time	t _f		-	4	-	nS
Total Gate Charge	Qg	N/ 00)// 05A	-	34.8	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =30V,I _D =25A,	-	7		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	5.3		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage	V _{SD}	V _{GS} =0V,I _S =25A	-		1.2	V
Diode Forward Current	ls		-	-	50	A
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F =25A	-	38	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs	-	48	-	nC

Notes:

1. EAS condition : Tj=25 $^\circ \!\! \mathbb{C}$,V_DD=30V,V_G=10V,L=0.5mH,Rg=25 Ω

2. Guaranteed by design, not subject to production

3. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsin k, assuming a maximum junction temperature of TJ(MAX)=150° C. The SOA curve provides a single pulse rating.











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NCEP6050AQU



Figure 11 Normalized Maximum Transient Thermal Impedance



DFN3.3X3.3-8L Package Information



Note:

- All Dimension Are In mm.
 Package Body Sizes Exclude Mold Flash, Protrusion Or Gate Burrs. Mold Flash, Protrusion Or Gate Burrs Shall Not Exceed 0.10 mm Per Side.
 Package Body Sizes Determined At The Outermost Extremes Of The Plastic Body Exclusive Of Mold Flash, Tie Bar Burrs, Gate Burrs And Interlead Flash, But Including Any Mismatch Between The Top And Bottom Of The Plastic Body.

	DIMENSIONAL REQMTS			
SYMBOL	MIN	NOM	MAX	
A	0.70	0.75	0.80	
b	0.25	0.30	0.35	
С	0.10	0.15	0.25	
D	3.25	3.35	3.45	
D1	3.00	3.10	3.20	
D2	1.78	1.88	1.98	
D3		0.13		
E	3.10	3.20	3.30	
E1	3.00	3.15	3.20	
E2	2.39	2.49	2.59	
е	0.65BSC			
Н	0.30	0.39	0.50	
L	0.30	0.40	0.50	
L1		0.13		
θ		10°	12°	
М	*	*	0.15	
* Not specified				





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